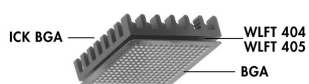


Data sheet Product ICK BGA 15 x 15 x 14

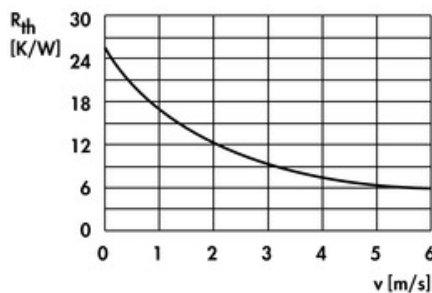
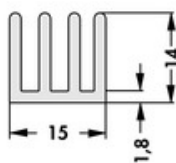
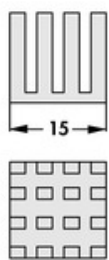


Heatsinks and active heatsinks for processors>Heatsinks for BGAs
15 x 15 x 14 mm, for IC design BGA and others

Features

way of fixation:	• therm. conductive foil • therm. cond. adhesive
socket:	universal
suitable for processor type:	universal
width:	15 mm
height:	14 mm
plate thickness:	1.8 mm
length:	15 mm
thermal resistance:	25.5 - 6.1 K/W
dissipation loss:	2.3 W
surface:	black anodised

Technical Drawing



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